

Weidmüller Interface GmbH & Co. KG

Klingenbergstraße 26 D-32758 Detmold Germany

www.weidmueller.com

Product image

















OMNIMATE® 4.0 - the next evolution step

OMNIMATE[®] 4.0 follows the trend of One Cable Technology (OCT). The modular concept enables the fast configuration of hybrid interfaces, which transmit data, signals and energy in a single connector. As a result, you can reduce the cabling effort in a wide variety of applications, simplify maintenance and accelerate automation processes. The unique SNAP IN connection is the backbone and speeds up the wiring process.

The fastest connection yet

- Fast, safe, and tool-free wiring due to unique SNAP IN connection
- Ready for Robot through "wire ready" delivery with open clamping point
- · Optical and acoustic feedback indicates proper wiring

Create your own configuration

- Flexible configuration and ordering via the Weidmüller Configurator (WMC)
- Dispatch within three days even for individually configured products
- Automatic offer preparation for the configurated product

Simply configuration of modular hybrid connectors

- Flexible combination options for power, signal and data transmission
- Future-proof Single-Pair Ethernet technology

General ordering data

/ersion	PCB plug-in connector, male header, THT/THR
Version	solder connection, Pitch in mm (P): 5.00 mm,
	Number of poles: 12, 180°, Tube
Order No.	<u>8000072470</u>
Туре	MHS 5/12 V T3 B T
GTIN (EAN)	4064675423188
Qty.	8 pc(s).
Product data	IEC: 400 V / 25.3 A
	UL: 300 V / 18.5 A
Packaging	Tube

Creation date September 2, 2023 4:24:49 AM CEST



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Technical data

Dimensions and weights

Depth	11.9 mm	Depth (inches)	0.469 inch
Height	17.2 mm	Height (inches)	0.677 inch
Height of lowest version	14 mm	Width	61.38 mm
Width (inches)	2.417 inch	Net weight	9.2 g

Temperatures

Operating temperature, min.	-50 °C	Operating temperature, max.	100 °C	

System specifications

Product family	OMNIMATE 4.0	Type of connection	Board connection
Product family			board connection
Mounting onto the PCB	THT/THR solder connection	Pitch in mm (P)	5 mm
Pitch in inches (P)	0.197 inch	Outgoing elbow	180°
Number of poles	12	Number of solder pins per pole	1
Solder pin length (I)	3.2 mm	Solder pin dimensions	1.0 x 1.0 mm
Solder eyelet hole diameter (D)	1.4 mm	Solder eyelet hole diameter tolerance (D)+ 0,1 mm
Outside diameter of solder pad	2.3 mm	Template aperture diameter	2.1 mm
L1 in mm	55 mm	L1 in inches	2.165 inch
Number of rows	1	Pin series quantity	1
Touch-safe protection acc. to DIN VDE 57 106	Touch-safe above the printed circuit board	Touch-safe protection acc. to DIN VDE 0470	IP 20
Protection degree	IP20	Volume resistance	≤5 mΩ
Plugging cycles	≥ 25	Plugging force/pole, max.	8.5 N
Pulling force/pole, max.	8.5 N		

Material data

Insulating material	PA 9T	Colour	black
Colour chart (similar)	RAL 9011	Insulating material group	1
Comparative Tracking Index (CTI)	≥ 600	Moisture Level (MSL)	1
UL 94 flammability rating	V-0	Contact base material	CuMg
Contact material	CuMg	Contact surface	tinned
Tinning type	matt	Storage temperature, min.	-25 °C
Storage temperature, max.	55 °C	Operating temperature, min.	-50 °C
Operating temperature, max.	100 °C		

Rated data acc. to IEC

tested acc. to standard	IEC 00004 1 IEC 01004	Rated current, min. number of poles	25.2.4
	IEC 60664-1, IEC 61984	(Tu=20°C)	25.3 A
Rated current, max. number of poles		Rated current, min. number of poles	
(Tu=20°C)	20.8 A	(Tu=40°C)	21.8 A
Rated current, max. number of poles		Rated voltage for surge voltage class /	
(Tu=40°C)	18 A	pollution degree II/2	400 V
Rated voltage for surge voltage class /		Rated voltage for surge voltage class /	
pollution degree III/2	320 V	pollution degree III/3	250 V
Rated impulse voltage for surge voltage		Rated impulse voltage for surge voltage	
class/ pollution degree II/2	4 kV	class/ pollution degree III/2	4 kV
Rated impulse voltage for surge voltage		Clearance, min.	
class/ contamination degree III/3	4 kV		4 mm
Creepage distance, min.	5.4 mm		



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Technical data

Rated data acc. to UL 1059			
Institute (cURus)		Certificate No. (cURus)	
	C THE US		E60693
Rated voltage (Use group B / UL 1059)	300 V	Rated voltage (Use group D / UL 1059)	300 V
Rated voltage (Use group F / UL 1059)	420 V	Rated current (Use group B / UL 1059)	18.5 A
Rated current (Use group D / UL 1059)	10 A	Clearance distance, min.	4 mm
Creepage distance, min.		Reference to approval values	Specifications are maximum values, details -
	5.6 mm		see approval certificate.
Classifications			
ETIM 6.0	EC002637	ETIM 7.0	EC002637
ETIM 8.0	EC002637	ECLASS 9.0	27-44-04-02
ECLASS 9.1	27-44-04-02	ECLASS 10.0	27-44-04-02
ECLASS 11.0	27-46-02-01	ECLASS 12.0	27-46-02-01
Important note			
IPC conformity	standards and norms and comp	eveloped, manufactured and delivered according bly with the assured properties in the data sheet i Class 2". Further claims on the products can be e	resp. fulfill decorative propertie
Notes		class 2 . Further claims on the products can be e	evaluated on request.

- · Rated data refer only to the component itself. Clearance and creepage distances to other components are to be designed in accordance with the relevant application standards.
- Diameter of solder eyelet D = 1.4+0.1mm

• P on drawing = pitch

• Long term storage of the product with average temperature of 50 °C and average humidity 70%, 36 months

Approvals

Approvals	
	C 7744 US

UL File Number Search	UL Website
Certificate No. (cURus)	E60693

Downloads

Approval/Certificate/Document of	
Conformity	Declaration of the Manufacturer
Engineering Data	CAD data – STEP
Catalogues	Catalogues in PDF-format



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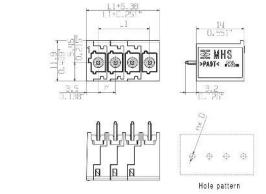
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Drawings

Product image

Dimensional drawing







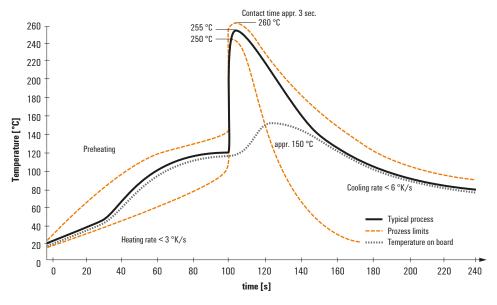
Recommended wave solderding profiles

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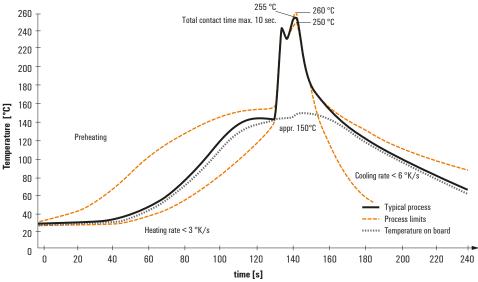
Klingenbergstraße 16 D-32758 Detmold Germany

Fon: +49 5231 14-0 Fax: +49 5231 14-292083 www.weidmueller.com

Single Wave:



Double Wave:



Wave soldering profiles

Wired connection elements should be processed in accordance with the DIN EN 61760-1 standard. We have included two recommendations for practical wave soldering profiles, with which Weidmüller PCB terminals and connectors are qualified.

When choosing a suitable profile for your application, the following factors also need to be considered:

- PCB thickness
- Proportion of Cu in the layers
- Single/double-sided assembly
- Product range
- Heating and cooling rates

The single and double wave profiles each indicate the recommended operating range, including the maximum soldering temperature of 260°C. In practice, the maximum soldering temperature is quite often well below the above maximum profile.

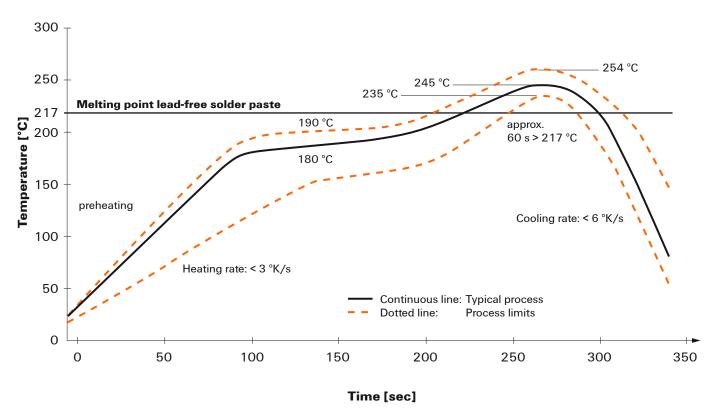


Recommended reflow soldering profile

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Reflow soldering profile

The perfect soldering profile for SMT Surface Mount Technology is one the most exiting question in SMT production. But there are more than one correct answer: The diagram of temperature-on-time is related to processing features of solder paste and to maximum load of components.

We have to consider the following parameters:

- · Time for pre heating
- Maximum temperature
- Time above melting point
- Time for cooling
- · Maximum heating rate
- · Maximum cooling rate

We recommend a typical solder profile with associated process limits. With preheating components and board are prepared smoothly for the solder phase. Heating rate is typically $\leq +3$ K/s. In parallel the solder paste is ,activated'. The time above melting point of 217°C the paste gets liquid and components and boards begin to connect. The maximum temperature of 245°C to 254°C should stay between 10 and 40 seconds. In the cooling phase at \geq -6K/s solder is cured. Board and components cool down while avoiding cold cracks.